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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	ARM® Cortex®-M0+
Core Size	32-Bit Single-Core
Speed	24MHz
Connectivity	I ² C, IrDA, LINbus, Microwire, SmartCard, SPI, SSP, UART/USART
Peripherals	Brown-out Detect/Reset, CapSense, LCD, LVD, POR, PWM, WDT
Number of I/O	36
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	1.71V ~ 5.5V
Data Converters	A/D 16x10b Slope, 16x12b SAR; D/A 2xIDAC
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-TQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy8c4124azi-s433

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Figure 1. Block Diagram



PSoC 4100S devices include extensive support for programming, testing, debugging, and tracing both hardware and firmware.

The ARM Serial-Wire Debug (SWD) interface supports all programming and debug features of the device.

Complete debug-on-chip functionality enables full-device debugging in the final system using the standard production device. It does not require special interfaces, debugging pods, simulators, or emulators. Only the standard programming connections are required to fully support debug.

The PSoC Creator IDE provides fully integrated programming and debug support for the PSoC 4100S devices. The SWD interface is fully compatible with industry-standard third-party tools. The PSoC 4100S family provides a level of security not possible with multi-chip application solutions or with microcontrollers. It has the following advantages:

- Allows disabling of debug features
- Robust flash protection
- Allows customer-proprietary functionality to be implemented in on-chip programmable blocks

The debug circuits are enabled by default and can be disabled in firmware. If they are not enabled, the only way to re-enable them is to erase the entire device, clear flash protection, and reprogram the device with new firmware that enables debugging. Thus firmware control of debugging cannot be over-ridden without erasing the firmware thus providing security.

Additionally, all device interfaces can be permanently disabled (device security) for applications concerned about phishing attacks due to a maliciously reprogrammed device or attempts to defeat security by starting and interrupting flash programming sequences. All programming, debug, and test interfaces are disabled when maximum device security is enabled. Therefore, PSoC 4100S, with device security enabled, may not be returned for failure analysis. This is a trade-off the PSoC 4100S allows the customer to make.



supports EZI2C that creates a mailbox address range in the memory of the PSoC 4100S and effectively reduces I²C communication to reading from and writing to an array in memory. In addition, the block supports an 8-deep FIFO for receive and transmit which, by increasing the time given for the CPU to read data, greatly reduces the need for clock stretching caused by the CPU not having read data on time.

The I²C peripheral is compatible with the I²C Standard-mode and Fast-mode devices as defined in the NXP I²C-bus specification and user manual (UM10204). The I²C bus I/O is implemented with GPIO in open-drain modes.

The PSoC 4100S is not completely compliant with the I²C spec in the following respect:

GPIO cells are not overvoltage tolerant and, therefore, cannot be hot-swapped or powered up independently of the rest of the I²C system.

UART Mode: This is a full-feature UART operating at up to 1 Mbps. It supports automotive single-wire interface (LIN), infrared interface (IrDA), and SmartCard (ISO7816) protocols, all of which are minor variants of the basic UART protocol. In addition, it supports the 9-bit multiprocessor mode that allows addressing of peripherals connected over common RX and TX lines. Common UART functions such as parity error, break detect, and frame error are supported. An 8-deep FIFO allows much greater CPU service latencies to be tolerated.

SPI Mode: The SPI mode supports full Motorola SPI, TI SSP (adds a start pulse used to synchronize SPI Codecs), and National Microwire (half-duplex form of SPI). The SPI block can use the FIFO.

GPIO

The PSoC 4100S has up to 36 GPIOs. The GPIO block implements the following:

- Eight drive modes:
 - Analog input mode (input and output buffers disabled)
 - □ Input only
 - Weak pull-up with strong pull-down
 - □ Strong pull-up with weak pull-down
 - Open drain with strong pull-down
 - □ Open drain with strong pull-up
 - □ Strong pull-up with strong pull-down
- Weak pull-up with weak pull-down
- Input threshold select (CMOS or LVTTL).
- Individual control of input and output buffer enabling/disabling in addition to the drive strength modes
- Selectable slew rates for dV/dt related noise control to improve EMI

The pins are organized in logical entities called ports, which are 8-bit in width (less for Ports 2 and 3). During power-on and reset, the blocks are forced to the disable state so as not to crowbar any inputs and/or cause excess turn-on current. A multiplexing network known as a high-speed I/O matrix is used to multiplex between various signals that may connect to an I/O pin.

Data output and pin state registers store, respectively, the values to be driven on the pins and the states of the pins themselves.

Every I/O pin can generate an interrupt if so enabled and each I/O port has an interrupt request (IRQ) and interrupt service routine (ISR) vector associated with it (5 for PSoC 4100S).

Special Function Peripherals

CapSense

CapSense is supported in the PSoC 4100S through a CapSense Sigma-Delta (CSD) block that can be connected to any pins through an analog multiplex bus via analog switches. CapSense function can thus be provided on any available pin or group of pins in a system under software control. A PSoC Creator component is provided for the CapSense block to make it easy for the user.

Shield voltage can be driven on another analog multiplex bus to provide water-tolerance capability. Water tolerance is provided by driving the shield electrode in phase with the sense electrode to keep the shield capacitance from attenuating the sensed input. Proximity sensing can also be implemented.

The CapSense block has two IDACs, which can be used for general purposes if CapSense is not being used (both IDACs are available in that case) or if CapSense is used without water tolerance (one IDAC is available).

The CapSense block also provides a 10-bit Slope ADC function which can be used in conjunction with the CapSense function.

The CapSense block is an advanced, low-noise, programmable block with programmable voltage references and current source ranges for improved sensitivity and flexibility. It can also use an external reference voltage. It has a full-wave CSD mode that alternates sensing to VDDA and ground to null out power-supply related noise.

LCD Segment Drive

The PSoC 4100S has an LCD controller, which can drive up to 4 commons and up to 32 segments. It uses full digital methods to drive the LCD segments requiring no generation of internal LCD voltages. The two methods used are referred to as Digital Correlation and PWM. Digital Correlation pertains to modulating the frequency and drive levels of the common and segment signals to generate the highest RMS voltage across a segment to light it up or to keep the RMS signal to zero. This method is good for STN displays but may result in reduced contrast with TN (cheaper) displays. PWM pertains to driving the panel with PWM signals to effectively use the capacitance of the panel to provide the integration of the modulated pulse-width to generate the desired LCD voltage. This method results in higher power consumption but can result in better results when driving TN displays. LCD operation is supported during Deep Sleep refreshing a small display buffer (4 bits; 1 32-bit register per port).



Alternate Pin Functions

Each Port pin has can be assigned to one of multiple functions; it can, for instance, be an analog I/O, a digital peripheral function, an LCD pin, or a CapSense pin. The pin assignments are shown in the following table.

Port/Pin	Analog	Smart I/O	Alternate Function 1	Alternate Function 2	Alternate Function 3	Deep Sleep 1	Deep Sleep 2
P0.0	lpcomp.in_p[0]				tcpwm.tr_in[0]	scb[2].i2c_scl:0	scb[0].spi_select1:0
P0.1	lpcomp.in_n[0]				tcpwm.tr_in[1]	scb[2].i2c_sda:0	scb[0].spi_select2:0
P0.2	lpcomp.in_p[1]						scb[0].spi_select3:0
P0.3	lpcomp.in_n[1]						scb[2].spi_select0
P0.4	wco.wco_in			scb[1].uart_rx:0	scb[2].uart_rx:0	scb[1].i2c_scl:0	scb[1].spi_mosi:1
P0.5	wco.wco_out			scb[1].uart_tx:0	scb[2].uart_tx:0	scb[1].i2c_sda:0	scb[1].spi_miso:1
P0.6			srss.ext_clk	scb[1].uart_cts:0	scb[2].uart_tx:1		scb[1].spi_clk:1
P0.7			tcpwm.line[0]:2	scb[1].uart_rts:0			scb[1].spi_select0:1
P1.0	ctb0_oa0+		tcpwm.line[2]:1	scb[0].uart_rx:1		scb[0].i2c_scl:0	scb[0].spi_mosi:1
P1.1	ctb0_oa0-		tcpwm.line_compl[2]:1	scb[0].uart_tx:1		scb[0].i2c_sda:0	scb[0].spi_miso:1
P1.2	ctb0_oa0_out		tcpwm.line[3]:1	scb[0].uart_cts:1	tcpwm.tr_in[2]	scb[2].i2c_scl:1	scb[0].spi_clk:1
P1.3	ctb0_oa1_out		tcpwm.line_compl[3]:1	scb[0].uart_rts:1	tcpwm.tr_in[3]	scb[2].i2c_sda:1	scb[0].spi_select0:1
P1.4	ctb0_oa1-						scb[0].spi_select1:1
P1.5	ctb0_oa1+						scb[0].spi_select2:1
P1.6	ctb0_oa0+						scb[0].spi_select3:1
P1.7	ctb0_oa1+ sar_ext_vref0 sar_ext_vref1						scb[2].spi_clk
P2.0	sarmux[0]	prgio[0].io[0]	tcpwm.line[4]:0	csd.comp	tcpwm.tr_in[4]	scb[1].i2c_scl:1	scb[1].spi_mosi:2
P2.1	sarmux[1]	prgio[0].io[1]	tcpwm.line_compl[4]:0		tcpwm.tr_in[5]	scb[1].i2c_sda:1	scb[1].spi_miso:2
P2.2	sarmux[2]	prgio[0].io[2]					scb[1].spi_clk:2
P2.3	sarmux[3]	prgio[0].io[3]					scb[1].spi_select0:2

PSoC[®] 4: PSoC 4100S Family Datasheet



Port/Pin	Analog	Smart I/O	Alternate Function 1	Alternate Function 2	Alternate Function 3	Deep Sleep 1	Deep Sleep 2
P2.4	sarmux[4]	prgio[0].io[4]	tcpwm.line[0]:1				scb[1].spi_select1:1
P2.5	sarmux[5]	prgio[0].io[5]	tcpwm.line_compl[0]:1				scb[1].spi_select2:1
P2.6	sarmux[6]	prgio[0].io[6]	tcpwm.line[1]:1				scb[1].spi_select3:1
P2.7	sarmux[7]	prgio[0].io[7]	tcpwm.line_compl[1]:1			lpcomp.comp[0]:1	scb[2].spi_mosi
P3.0		prgio[1].io[0]	tcpwm.line[0]:0	scb[1].uart_rx:1		scb[1].i2c_scl:2	scb[1].spi_mosi:0
P3.1		prgio[1].io[1]	tcpwm.line_compl[0]:0	scb[1].uart_tx:1		scb[1].i2c_sda:2	scb[1].spi_miso:0
P3.2		prgio[1].io[2]	tcpwm.line[1]:0	scb[1].uart_cts:1		cpuss.swd_data	scb[1].spi_clk:0
P3.3		prgio[1].io[3]	tcpwm.line_compl[1]:0	scb[1].uart_rts:1		cpuss.swd_clk	scb[1].spi_select0:0
P3.4		prgio[1].io[4]	tcpwm.line[2]:0		tcpwm.tr_in[6]		scb[1].spi_select1:0
P3.5		prgio[1].io[5]	tcpwm.line_compl[2]:0				scb[1].spi_select2:0
P3.6		prgio[1].io[6]	tcpwm.line[3]:0				scb[1].spi_select3:0
P3.7		prgio[1].io[7]	tcpwm.line_compl[3]:0			lpcomp.comp[1]:1	scb[2].spi_miso
P4.0	csd.vref_ext			scb[0].uart_rx:0		scb[0].i2c_scl:1	scb[0].spi_mosi:0
P4.1	csd.cshieldpads			scb[0].uart_tx:0		scb[0].i2c_sda:1	scb[0].spi_miso:0
P4.2	csd.cmodpad			scb[0].uart_cts:0		lpcomp.comp[0]:0	scb[0].spi_clk:0
P4.3	csd.csh_tank			scb[0].uart_rts:0		lpcomp.comp[1]:0	scb[0].spi_select0:0



Power

The following power system diagram shows the set of power supply pins as implemented for the PSoC 4100S. The system has one regulator in Active mode for the digital circuitry. There is no analog regulator; the analog circuits run directly from the V_{DD} input.

Figure 4. Power Supply Connections



There are two distinct modes of operation. In Mode 1, the supply voltage range is 1.8 V to 5.5 V (unregulated externally; internal regulator operational). In Mode 2, the supply range is $1.8 \text{ V} \pm 5\%$ (externally regulated; 1.71 to 1.89, internal regulator bypassed).

Mode 1: 1.8 V to 5.5 V External Supply

In this mode, the PSoC 4100S is powered by an external power supply that can be anywhere in the range of 1.8 to 5.5 V. This range is also designed for battery-powered operation. For example, the chip can be powered from a battery system that starts at 3.5 V and works down to 1.8 V. In this mode, the internal regulator of the PSoC 4100S supplies the internal logic and its output is connected to the V_{CCD} pin. The VCCD pin must be bypassed to ground via an external capacitor (0.1 μ F; X5R ceramic or better) and must not be connected to anything else.

Mode 2: 1.8 V ±5% External Supply

In this mode, the PSoC 4100S is powered by an external power supply that must be within the range of 1.71 to 1.89 V; note that this range needs to include the power supply ripple too. In this mode, the VDD and VCCD pins are shorted together and bypassed. The internal regulator can be disabled in the firmware.

Bypass capacitors must be used from VDDD to ground. The typical practice for systems in this frequency range is to use a capacitor in the 1- μ F range, in parallel with a smaller capacitor (0.1 μ F, for example). Note that these are simply rules of thumb and that, for critical applications, the PCB layout, lead inductance, and the bypass capacitor parasitic should be simulated to design and obtain optimal bypassing.

An example of a bypass scheme is shown in the following diagram.

Figure 5. External Supply Range from 1.8 V to 5.5 V with Internal Regulator Active

Power supply bypass connections example





Analog Peripherals

Table 9. CTBm Opamp Specifications

Spec ID#	Parameter	Description	Min	Тур	Max	Units	Details/ Conditions
	I _{DD}	Opamp block current, External load		I			
SID269	I _{DD_HI}	power=hi	_	1100	1850		_
SID270	I _{DD_MED}	power=med	-	550	950	μΑ	_
SID271	I _{DD_LOW}	power=lo	-	150	350	-	-
	G _{BW}	Load = 20 pF, 0.1 mA V _{DDA} = 2.7 V					
SID272	G _{BW_HI}	power=hi	6	_	_		Input and output are 0.2 V to V_{DDA} -0.2 V
SID273	G _{BW_MED}	power=med	3	-	-	MHz	Input and output are 0.2 V to V _{DDA} -0.2 V
SID274	G _{BW_LO}	power=lo	_	1	-		Input and output are 0.2 V to V_{DDA} -0.2 V
	I _{OUT_MAX}	V_{DDA} = 2.7 V, 500 mV from rail				-	
SID275	I _{OUT_MAX_HI}	power=hi	10	_	_		Output is 0.5 V V _{DDA} -0.5 V
SID276	I _{OUT_MAX_MID}	power=mid	10	_	-	mA	Output is 0.5 V V _{DDA} -0.5 V
SID277	I _{OUT_MAX_LO}	power=lo	-	5	-		Output is 0.5 V V _{DDA} -0.5 V
	I _{OUT}	V_{DDA} = 1.71 V, 500 mV from rail					
SID278	I _{OUT_MAX_HI}	power=hi	4	_	_		Output is 0.5 V V _{DDA} -0.5 V
SID279	IOUT_MAX_MID	power=mid	4	-	-	mA	Output is 0.5 V V _{DDA} -0.5 V
SID280	I _{OUT_MAX_LO}	power=lo	-	2	-		Output is 0.5 V V _{DDA} -0.5 V
	I _{DD_Int}	Opamp block current Internal Load				•	
SID269_I	I _{DD_HI_Int}	power=hi	-	1500	1700		_
SID270_I	I _{DD_MED_Int}	power=med	-	700	900	μA	_
	I _{DD_LOW_Int}	power=lo	_	_	_		-
SID271_I	G _{BW}	V _{DDA} = 2.7 V	_	_	_		-
SID272_I	G _{BW_HI_Int}	power=hi	8	_	_	MHz	Output is 0.25 V to V _{DDA} -0.25 V



Table 9. CTBm Opamp Specifications (continued)

Spec ID#	Parameter	Description	Min	Тур	Max	Units	Details/ Conditions
		General opamp specs for both internal and external modes					
SID281	V _{IN}	Charge-pump on, V _{DDA} = 2.7 V	-0.05	_	V _{DDA} -0.2	V	-
SID282	V _{CM}	Charge-pump on, V_{DDA} = 2.7 V	-0.05	-	V _{DDA} -0.2		-
	V _{OUT}	V _{DDA} = 2.7 V					
SID283	V _{OUT_1}	power=hi, lload=10 mA	0.5	_	V _{DDA} -0.5		_
SID284	V _{OUT_2}	power=hi, lload=1 mA	0.2	_	V _{DDA} -0.2	V	-
SID285	V _{OUT_3}	power=med, lload=1 mA	0.2	_	V _{DDA} -0.2	·	_
SID286	V _{OUT_4}	power=lo, lload=0.1 mA	0.2	_	V _{DDA} -0.2		_
SID288	V _{OS_TR}	Offset voltage, trimmed	-1.0	±0.5	1.0		High mode, input 0 V to V _{DDA} -0.2 V
SID288A	V _{OS_TR}	Offset voltage, trimmed	-	±1	-	mV	Medium mode, input 0 V to V _{DDA} -0.2 V
SID288B	V _{OS_TR}	Offset voltage, trimmed	-	±2	-		Low mode, input 0 V to V _{DDA} -0.2 V
SID290	V _{OS_DR_TR}	Offset voltage drift, trimmed	-10	±3	10	μV/C	High mode
SID290A	V _{OS_DR_TR}	Offset voltage drift, trimmed	-	±10	-		Medium mode
SID290B	V _{OS_DR_TR}	Offset voltage drift, trimmed	-	±10	-	μν/C	Low mode
SID291	CMRR	DC	70	80	_		Input is 0 V to V_{DDA} -0.2 V, Output is 0.2 V to V_{DDA} -0.2 V
SID292	PSRR	At 1 kHz, 10-mV ripple	70	85	_	dB	V_{DDD} = 3.6 V, high-power mode, input is 0.2 V to V_{DDA} -0.2 V
	Noise						
SID294	VN2	Input-referred, 1 kHz, power=Hi	-	72	-		3
SID295	VN3	Input-referred, 10 kHz, power=Hi	-	28	-	nV/rtHz	Input and output are at 0.2 V to V_{DDA} -0.2 V
SID296	VN4	Input-referred, 100 kHz, power=Hi	-	15	-		Input and output are at 0.2 V to V_{DDA} -0.2 V
SID297	C _{LOAD}	Stable up to max. load. Performance specs at 50 pF.	_	_	125	pF	_
SID298	SLEW_RATE	Cload = 50 pF, Power = High, V_{DDA} = 2.7 V	6	_	_	V/µs	-



Table 9. CTBm Opamp Specifications (continued)

Spec ID#	Parameter	Description	Min	Тур	Max	Units	Details/ Conditions
SID299	T_OP_WAKE	From disable to enable, no external RC dominating	Ι	_	25	μs	_
SID299A	OL_GAIN	Open Loop Gain	_	90	-	dB	
	COMP_MODE	Comparator mode; 50 mV drive, T _{rise} =T _{fall} (approx.)					
SID300	TPD1	Response time; power=hi	Ι	150	Ι		Input is 0.2 V to V _{DDA} -0.2 V
SID301	TPD2	Response time; power=med	Ι	500	Ι	ns	Input is 0.2 V to V _{DDA} -0.2 V
SID302	TPD3	Response time; power=lo	Ι	2500	Ι		Input is 0.2 V to V _{DDA} -0.2 V
SID303	VHYST_OP	Hysteresis	-	10	_	mV	-
SID304	WUP_CTB	Wake-up time from Enabled to Usable	-	-	25	μs	-
	Deep Sleep Mode	Mode 2 is lowest current range. Mode 1 has higher GBW.					
SID_DS_1	I _{DD_HI_M1}	Mode 1, High current	-	1400	_		25 °C
SID_DS_2	I _{DD_MED_M1}	Mode 1, Medium current	-	700	_		25 °C
SID_DS_3	I _{DD_LOW_M1}	Mode 1, Low current	-	200	-		25 °C
SID_DS_4	I _{DD_HI_M2}	Mode 2, High current	-	120	-	μΑ	25 °C
SID_DS_5	I _{DD_MED_M2}	Mode 2, Medium current	-	60	-		25 °C
SID_DS_6	IDD_LOW_M2	Mode 2, Low current	-	15	-		25 °C



Table 9. CTBm Opamp Specifications (continued)

Spec ID#	Parameter	Description	Min	Тур	Max	Units	Details/ Conditions
SID_DS_7	G _{BW_HI_M1}	Mode 1, High current	-	4	-		20-pF load, no DC load 0.2 V to V _{DDA} -0.2 V
SID_DS_8	G _{BW_MED_M1}	Mode 1, Medium current	-	2	_		20-pF load, no DC load 0.2 V to V _{DDA} -0.2 V
SID_DS_9	G _{BW_LOW_M!}	Mode 1, Low current	_	0.5	-	MLI-	20-pF load, no DC load 0.2 V to V _{DDA} -0.2 V
SID_DS_10	G _{BW_HI_M2}	Mode 2, High current	_	0.5	_		20-pF load, no DC load 0.2 V to V _{DDA} -0.2 V
SID_DS_11	G _{BW_MED_M2}	Mode 2, Medium current	_	0.2	_		20-pF load, no DC load 0.2 V to V _{DDA} -0.2 V
SID_DS_12	G _{BW_Low_M2}	Mode 2, Low current	_	0.1	_		20-pF load, no DC load 0.2 V to V _{DDA} -0.2 V
SID_DS_13	V _{OS_HI_M1}	Mode 1, High current	-	5	-		With trim 25 °C, 0.2 V to V _{DDA} -0.2 V
SID_DS_14	V _{OS_MED_M1}	Mode 1, Medium current	-	5	_		With trim 25 °C, 0.2 V to V_{DDA} -0.2 V
SID_DS_15	V _{OS_LOW_M2}	Mode 1, Low current	-	5	_		With trim 25 °C, 0.2 V to V_{DDA} -0.2 V
SID_DS_16	V _{OS_HI_M2}	Mode 2, High current	-	5	_	mv	With trim 25 °C, 0.2V to V _{DDA} -0.2 V
SID_DS_17	V _{OS_MED_M2}	Mode 2, Medium current	_	5	Ι		With trim 25 °C, 0.2 V to V _{DDA} -0.2 V
SID_DS_18	V _{OS_LOW_M2}	Mode 2, Low current	_	5	-		With trim 25 °C, 0.2 V to V_{DDA} -0.2 V
SID_DS_19	I _{OUT_HI_M!}	Mode 1, High current	_	10	-		Output is 0.5 V to V _{DDA} -0.5 V
SID_DS_20	I _{OUT_MED_M1}	Mode 1, Medium current	_	10	Ι		Output is 0.5 V to V _{DDA} -0.5 V
SID_DS_21	I _{OUT_LOW_M1}	Mode 1, Low current	-	4	_		Output is 0.5 V to V _{DDA} -0.5 V
SID_DS_22	I _{OUT_HI_M2}	Mode 2, High current	-	1	_	MA	
SID_DS_23	I _{OU_MED_M2}	Mode 2, Medium current	_	1	_		
SID_DS_24	I _{OU_LOW_M2}	Mode 2, Low current	_	0.5	_		

Note 6. Guaranteed by characterization.



Table 10. Comparator DC Specifications

Spec ID#	Parameter	Description	Min	Тур	Мах	Units	Details/ Conditions
SID84	V _{OFFSET1}	Input offset voltage, Factory trim	-	-	±10		
SID85	V _{OFFSET2}	Input offset voltage, Custom trim	-	-	±4	mV	
SID86	V _{HYST}	Hysteresis when enabled	-	10	35		
SID87	V _{ICM1}	Input common mode voltage in normal mode	0	-	V _{DDD} -0.1		Modes 1 and 2
SID247	V _{ICM2}	Input common mode voltage in low power mode	0	-	V _{DDD}	v	
SID247A	V _{ICM3}	Input common mode voltage in ultra low power mode	0	-	V _{DDD} -1.15		V _{DDD} ≥ 2.2 V at _40 °C
SID88	C _{MRR}	Common mode rejection ratio	50	-	-	dB	$V_{DDD} \ge 2.7V$
SID88A	C _{MRR}	Common mode rejection ratio	42	-	-	uв	$V_{DDD} \le 2.7V$
SID89	I _{CMP1}	Block current, normal mode	-	-	400		
SID248	I _{CMP2}	Block current, low power mode	-	-	100	uА	
SID259	I _{CMP3}	Block current in ultra low-power mode	-	-	6	Pre -	V _{DDD} ≥ 2.2 V at _40 °C
SID90	Z _{CMP}	DC Input impedance of comparator	35	-	_	MΩ	

Table 11. Comparator AC Specifications

Spec ID#	Parameter	Description	Min	Тур	Max	Units	Details/ Conditions
SID91	TRESP1	Response time, normal mode, 50 mV overdrive	-	38	110		
SID258	TRESP2	Response time, low power mode, 50 mV overdrive	-	70	200	ns	
SID92	TRESP3	Response time, ultra-low power mode, 200 mV overdrive	-	2.3	15	μs	V _{DDD} ≥ 2.2 V at _40 °C

Table 12. Temperature Sensor Specifications

Spec ID#	Parameter	Description	Min	Тур	Max	Units	Details / Conditions
SID93	TSENSACC	Temperature sensor accuracy	-5	±1	5	°C	–40 to +85 °C

Table 13. SAR Specifications

Spec ID#	Parameter	Description	Min	Тур	Max	Units	Details/ Conditions		
SAR ADC DC Specifications									
SID94	A_RES	Resolution	-	-	12	bits			
SID95	A_CHNLS_S	Number of channels - single ended	-	-	16				
SID96	A-CHNKS_D	Number of channels - differential	-	-	4		Diff inputs use neighboring I/O		
SID97	A-MONO	Monotonicity	-	-	_		Yes.		
SID98	A_GAINERR	Gain error	-	-	±0.1	%	With external reference.		



CSD

Table 14. CSD and IDAC Specifications

SPEC ID#	Parameter	Description	Min	Тур	Max	Units	Details / Conditions
SYS.PER#3	VDD_RIPPLE	Max allowed ripple on power supply, DC to 10 MHz	-	-	±50	mV	V _{DD} > 2 V (with ripple), 25 °C T _A , Sensitivity = 0.1 pF
SYS.PER#16	VDD_RIPPLE_1.8	Max allowed ripple on power supply, DC to 10 MHz	-	_	±25	mV	V_{DD} > 1.75V (with ripple), 25 °C T _A , Parasitic Capaci- tance (C _P) < 20 pF, Sensitivity ≥ 0.4 pF
SID.CSD.BLK	ICSD	Maximum block current	-	-	4000	μA	Maximum block current for both IDACs in dynamic (switching) mode including comparators, buffer, and reference generator.
SID.CSD#15	V _{REF}	Voltage reference for CSD and Comparator	0.6	1.2	V _{DDA} - 0.6	V	V _{DDA} - 0.06 or 4.4, whichever is lower
SID.CSD#15A	VREF_EXT	External Voltage reference for CSD and Comparator	0.6		V _{DDA} - 0.6	V	V _{DDA} - 0.06 or 4.4, whichever is lower
SID.CSD#16	IDAC1IDD	IDAC1 (7-bits) block current	-	-	1750	μA	
SID.CSD#17	IDAC2IDD	IDAC2 (7-bits) block current	_	-	1750	μA	
SID308	VCSD	Voltage range of operation	1.71	-	5.5	V	1.8 V ±5% or 1.8 V to 5.5 V
SID308A	VCOMPIDAC	Voltage compliance range of IDAC	0.6	-	V _{DDA} –0.6	V	V _{DDA} - 0.06 or 4.4, whichever is lower
SID309	IDAC1DNL	DNL	-1	-	1	LSB	
SID310	IDAC1INL	INL	-2	-	2	LSB	INL is ± 5.5 LSB for V _{DDA} < 2 V
SID311	IDAC2DNL	DNL	-1	-	1	LSB	
SID312	IDAC2INL	INL	-2	-	2	LSB	INL is ±5.5 LSB for V _{DDA} < 2 V
SID313	SNR	Ratio of counts of finger to noise. Guaranteed by characterization	5	-	-	Ratio	Capacitance range of 5 to 35 pF, 0.1-pF sensitivity. All use cases. V _{DDA} > 2 V.
SID314	IDAC1CRT1	Output current of IDAC1 (7 bits) in low range	4.2	-	5.4	μA	LSB = 37.5-nA typ.
SID314A	IDAC1CRT2	Output current of IDAC1(7 bits) in medium range	34	-	41	μA	LSB = 300-nA typ.
SID314B	IDAC1CRT3	Output current of IDAC1(7 bits) in high range	275	-	330	μΑ	LSB = 2.4-µA typ.
SID314C	IDAC1CRT12	Output current of IDAC1 (7 bits) in low range, 2X mode	8	_	10.5	μΑ	LSB = 75-nA typ.
SID314D	IDAC1CRT22	Output current of IDAC1(7 bits) in medium range, 2X mode	69	_	82	μΑ	LSB = 600-nA typ.
SID314E	IDAC1CRT32	Output current of IDAC1(7 bits) in high range, 2X mode	540	_	660	μΑ	LSB = 4.8-µA typ.
SID315	IDAC2CRT1	Output current of IDAC2 (7 bits) in low range	4.2	-	5.4	μA	LSB = 37.5-nA typ.
SID315A	IDAC2CRT2	Output current of IDAC2 (7 bits) in medium range	34	-	41	μA	LSB = 300-nA typ.
SID315B	IDAC2CRT3	Output current of IDAC2 (7 bits) in high range	275	-	330	μA	LSB = 2.4-µA typ.
SID315C	IDAC2CRT12	Output current of IDAC2 (7 bits) in low range, 2X mode	8	-	10.5	μA	LSB = 75-nA typ.
SID315D	IDAC2CRT22	Output current of IDAC2(7 bits) in medium range, 2X mode	69	_	82	μA	LSB = 600-nA typ.
SID315E	IDAC2CRT32	Output current of IDAC2(7 bits) in high range, 2X mode	540	-	660	μA	LSB = 4.8-µA typ.
SID315F	IDAC3CRT13	Output current of IDAC in 8-bit mode in low range	8	-	10.5	μA	LSB = 37.5-nA typ.



Table 14. CSD and IDAC Specifications (continued)

SPEC ID#	Parameter	Description	Min	Тур	Max	Units	Details / Conditions
SID315G	IDAC3CRT23	Output current of IDAC in 8-bit mode in medium range	69	-	82	μA	LSB = 300-nA typ.
SID315H	IDAC3CRT33	Output current of IDAC in 8-bit mode in high range	540	-	660	μΑ	LSB = 2.4-µA typ.
SID320	IDACOFFSET	All zeroes input	_	-	1	LSB	Polarity set by Source or Sink. Offset is 2 LSBs for 37.5 nA/LSB mode
SID321	IDACGAIN	Full-scale error less offset	-	-	±10	%	
SID322	IDACMISMATCH1	Mismatch between IDAC1 and IDAC2 in Low mode	-	-	9.2	LSB	LSB = 37.5-nA typ.
SID322A	IDACMISMATCH2	Mismatch between IDAC1 and IDAC2 in Medium mode	-	-	5.6	LSB	LSB = 300-nA typ.
SID322B	IDACMISMATCH3	Mismatch between IDAC1 and IDAC2 in High mode	-	-	6.8	LSB	LSB = 2.4-µA typ.
SID323	IDACSET8	Settling time to 0.5 LSB for 8-bit IDAC	-	-	10	μs	Full-scale transition. No external load.
SID324	IDACSET7	Settling time to 0.5 LSB for 7-bit IDAC	_	-	10	μs	Full-scale transition. No external load.
SID325	CMOD	External modulator capacitor.	-	2.2	-	nF	5-V rating, X7R or NP0 cap.

Table 15. 10-bit CapSense ADC Specifications

Spec ID#	Parameter	Description	Min	Тур	Мах	Units	Details/ Conditions
SIDA94	A_RES	Resolution	-	-	10	bits	Auto-zeroing is required every millisecond
SIDA95	A_CHNLS_S	Number of channels - single ended	-	-	16		Defined by AMUX Bus.
SIDA97	A-MONO	Monotonicity	-	-	-	Yes	
SIDA98	A_GAINERR	Gain error	-	-	±2	%	In V_{REF} (2.4 V) mode with V_{DDA} bypass capacitance of 10 μ F
SIDA99	A_OFFSET	Input offset voltage	-	-	3	mV	In V_{REF} (2.4 V) mode with V_{DDA} bypass capacitance of 10 μ F
SIDA100	A_ISAR	Current consumption	-	-	0.25	mA	
SIDA101	A_VINS	Input voltage range - single ended	V _{SSA}	-	V _{DDA}	V	
SIDA103	A_INRES	Input resistance	_	2.2	-	KΩ	
SIDA104	A_INCAP	Input capacitance	_	20	-	pF	
SIDA106	A_PSRR	Power supply rejection ratio	-	60	_	dB	In V_{REF} (2.4 V) mode with V_{DDA} bypass capacitance of 10 μ F
SIDA107	A_TACQ	Sample acquisition time	-	1	-	μs	
SIDA108	A_CONV8	Conversion time for 8-bit resolution at conversion rate = Fhclk/(2 [^] (N+2)). Clock frequency = 48 MHz.	_	-	21.3	μs	Does not include acqui- sition time. Equivalent to 44.8 ksps including acquisition time.
SIDA108A	A_CONV10	Conversion time for 10-bit resolution at conversion rate = Fhclk/(2 [^] (N+2)). Clock frequency = 48 MHz.	_	-	85.3	μs	Does not include acqui- sition time. Equivalent to 11.6 ksps including acquisition time.



Table 15.	10-bit Ca	oSense	ADC S	pecifications	(continued))

Spec ID#	Parameter	Description	Min	Тур	Мах	Units	Details/ Conditions
SIDA109	A_SND	Signal-to-noise and Distortion ratio (SINAD)	-	61	-	dB	With 10-Hz input sine wave, external 2.4-V reference, V _{REF} (2.4 V) mode
SIDA110	A_BW	Input bandwidth without aliasing	_	-	22.4	KHz	8-bit resolution
SIDA111	A_INL	Integral Non Linearity. 1 ksps	-	-	2	LSB	V _{REF} = 2.4 V or greater
SIDA112	A_DNL	Differential Non Linearity. 1 ksps	1	-	1	LSB	

Digital Peripherals

Timer Counter Pulse-Width Modulator (TCPWM)

Table 16. TCPWM Specifications

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID.TCPWM.1	ITCPWM1	Block current consumption at 3 MHz	-	Ι	45		All modes (TCPWM)
SID.TCPWM.2	ITCPWM2	Block current consumption at 12 MHz	_	-	155	μA	All modes (TCPWM)
SID.TCPWM.2A	ITCPWM3	Block current consumption at 48 MHz	-	-	650		All modes (TCPWM)
SID.TCPWM.3	TCPWM _{FREQ}	Operating frequency	_	_	Fc	MHz	Fc max = CLK_SYS Maximum = 48 MHz
SID.TCPWM.4	TPWM _{ENEXT}	Input trigger pulse width	2/Fc	-	-		For all trigger events ^[7]
SID.TCPWM.5	TPWM _{EXT}	Output trigger pulse widths	2/Fc	_	_		Minimum possible width of Overflow, Underflow, and CC (Counter equals Compare value) outputs
SID.TCPWM.5A	TC _{RES}	Resolution of counter	1/Fc	_	_	ns	Minimum time between successive counts
SID.TCPWM.5B	PWM _{RES}	PWM resolution	1/Fc	-	-		Minimum pulse width of PWM Output
SID.TCPWM.5C	Q _{RES}	Quadrature inputs resolution	1/Fc	_	_		Minimum pulse width between Quadrature phase inputs

ľC

Table 17. Fixed I²C DC Specifications^[8]

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID149	I _{I2C1}	Block current consumption at 100 kHz	-	-	50		_
SID150	I _{I2C2}	Block current consumption at 400 kHz	-	-	135	μA	_
SID151	I _{I2C3}	Block current consumption at 1 Mbps	-	-	310		_
SID152	I _{I2C4}	I ² C enabled in Deep Sleep mode	-	-	1.4		

Table 18. Fixed I²C AC Specifications^[8]

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID153	F _{I2C1}	Bit rate	-	-	1	Msps	-

Notes

7. Trigger events can be Stop, Start, Reload, Count, Capture, or Kill depending on which mode of operation is selected.

Note

8. Guaranteed by characterization.



Table 21. UART DC Specifications^[9]

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID160	I _{UART1}	Block current consumption at 100 Kbps	_	-	55	μA	_
SID161	I _{UART2}	Block current consumption at 1000 Kbps	_	_	312	μA	_

Table 22. UART AC Specifications^[9]

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID162	F _{UART}	Bit rate	_	Ι	1	Mbps	_

Table 23. LCD Direct Drive DC Specifications^[9]

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID154	I _{LCDLOW}	Operating current in low power mode	I	5	Ι	μA	16 × 4 small segment disp. at 50 Hz
SID155	C _{LCDCAP}	LCD capacitance per segment/common driver	-	500	5000	pF	-
SID156	LCD _{OFFSET}	Long-term segment offset	-	20	-	mV	-
SID157	I _{LCDOP1}	LCD system operating current Vbias = 5 V	I	2	Ι	m۸	32×4 segments. 50 Hz. 25 °C
SID158	I _{LCDOP2}	LCD system operating current Vbias = 3.3 V	_	2	_	mА	32×4 segments. 50 Hz. 25 °C

Table 24. LCD Direct Drive AC Specifications^[9]

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID159	F _{LCD}	LCD frame rate	10	50	150	Hz	-



SWD Interface

Table 29. SWD Interface Specifications

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID213	F_SWDCLK1	$3.3~V \leq V_{DD} \leq 5.5~V$	-	-	14		SWDCLK ≤ 1/3 CPU clock frequency
SID214	F_SWDCLK2	$1.71 \text{ V} \leq \text{V}_{DD} \leq 3.3 \text{ V}$	-	-	7		SWDCLK ≤ 1/3 CPU clock frequency
SID215 ^[12]	T_SWDI_SETUP	T = 1/f SWDCLK	0.25*T	-	-		-
SID216 ^[12]	T_SWDI_HOLD	T = 1/f SWDCLK	0.25*T	-	-	ne	-
SID217 ^[12]	T_SWDO_VALID	T = 1/f SWDCLK	-	-	0.5*T	115	-
SID217A ^[12]	T_SWDO_HOLD	T = 1/f SWDCLK	1	-	-		_

Internal Main Oscillator

Table 30. IMO DC Specifications

(Guaranteed by Design)

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID218	I _{IMO1}	IMO operating current at 48 MHz	-	-	250	μA	-
SID219	I _{IMO2}	IMO operating current at 24 MHz	Ι	Ι	180	μA	-

Table 31. IMO AC Specifications

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID223	F _{IMOTOL1}	Frequency variation at 24, 32, and 48 MHz (trimmed)	-	-	±2	%	
SID226	T _{STARTIMO}	IMO startup time	-	-	7	μs	-
SID228	T _{JITRMSIMO2}	RMS jitter at 24 MHz	-	145	-	ps	-

Internal Low-Speed Oscillator

Table 32. ILO DC Specifications

(Guaranteed by Design)

Spec ID	Parameter	Description	Min	Typ Max		Units	Details/Conditions	
SID231 ^[12]	I _{ILO1}	ILO operating current	_	0.3	1.05	μA	_	

Table 33. ILO AC Specifications

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID234 ^[12]	T _{STARTILO1}	ILO startup time	-	-	2	ms	_
SID236 ^[12]	T _{ILODUTY}	ILO duty cycle	40	50	60	%	-
SID237	F _{ILOTRIM1}	ILO frequency range	20	40	80	kHz	_



Ordering Information

The marketing part numbers for the PSoC 4100S family are listed in the following table.

	Features								Package										
Category	MPN	Max CPU Speed (MHz)	Flash (KB)	SRAM (KB)	Opamp (CTBm)	CSD	10-bit CSD ADC	12-bit SAR ADC	ADC Sample Rate	LP Comparators	TCPWM Blocks	SCB Blocks	Smart I/Os	GPIO	35-WLCSP (0.35mm pitch)	32-QFN	40-QFN	48-TQFP	44-TQFP
	CY8C4124FNI-S403	24	16	4	2	0	1	0		2	5	2	8	31	Х				
	CY8C4124FNI-S413	24	16	4	2	1	1	0		2	5	2	16	31	Х				
	CY8C4124LQI-S412	24	16	4	2	1	1	0		2	5	2	16	27		Х			
	CY8C4124LQI-S413	24	16	4	2	1	1	0		2	5	2	16	34			Х		
4124	CY8C4124AZI-S413	24	16	4	2	1	1	0		2	5	2	16	36				Х	
	CY8C4124FNI-S433	24	16	4	2	1	1	1	806 ksps	2	5	2	16	31	Х				
	CY8C4124LQI-S432	24	16	4	2	1	1	1	806 ksps	2	5	2	16	27		Х			
	CY8C4124LQI-S433	24	16	4	2	1	1	1	806 ksps	2	5	2	16	34			Х		
	CY8C4124AZI-S433	24	16	4	2	1	1	1	806 ksps	2	5	2	16	36				Х	
	CY8C4125FNI-S423	24	32	4	2	0	1	1	806 ksps	2	5	2	16	31	Х				
	CY8C4125LQI-S422	24	32	4	2	0	1	1	806 ksps	2	5	2	16	27		Х			
	CY8C4125LQI-S423	24	32	4	2	0	1	1	806 ksps	2	5	2	16	34			Х		
	CY8C4125AZI-S423	24	32	4	2	0	1	1	806 ksps	2	5	2	16	36				Х	
	CY8C4125AXI-S423	24	32	4	2	0	1	1	806 ksps	2	5	2	16	36					Х
	CY8C4125FNI-S413	24	32	4	2	1	1	0		2	5	2	16	31	Х				
4125	CY8C4125LQI-S412	24	32	4	2	1	1	0		2	5	2	16	27		Х			
1120	CY8C4125LQI-S413	24	32	4	2	1	1	0		2	5	2	16	34			Х		
	CY8C4125AZI-S413	24	32	4	2	1	1	0		2	5	2	16	36				Х	
	CY8C4125FNI-S433	24	32	4	2	1	1	1	806 ksps	2	5	2	16	31	Х				
	CY8C4125LQI-S432	24	32	4	2	1	1	1	806 ksps	2	5	2	16	27		Х			
	CY8C4125LQI-S433	24	32	4	2	1	1	1	806 ksps	2	5	2	16	34			Х		
	CY8C4125AZI-S433	24	32	4	2	1	1	1	806 ksps	2	5	2	16	36				Х	
	CY8C4125AXI-S433	24	32	4	2	1	1	1	806 ksps	2	5	2	16	36					Х
	CY8C4126AZI-S423	24	64	8	2	0	1	1	806 ksps	2	5	3	16	36				Х	
4126	CY8C4126AXI-S423	24	64	8	2	0	1	1	806 ksps	2	5	3	16	36					Х
	CY8C4126AZI-S433	24	64	8	2	1	1	1	806 ksps	2	5	3	16	36				Х	
	CY8C4126AXI-S433	24	64	8	2	1	1	1	806 ksps	2	5	3	16	36					Х
	CY8C4145AZI-S423	48	32	4	2	0	1	1	1 Msps	2	5	2	16	36				Х	
4145	CY8C4145AXI-S423	48	32	4	2	0	1	1	1 Msps	2	5	2	16	36					Х
	CY8C4145AXI-S433	48	32	4	2	1	1	1	1 Msps	2	5	2	16	36					Х
	CY8C4146FNI-S423	48	64	8	2	0	1	1	1 Msps	2	5	3	16	31	Х				
	CY8C4146LQI-S422	48	64	8	2	0	1	1	1 Msps	2	5	3	16	27		Х			
	CY8C4146LQI-S423	48	64	8	2	0	1	1	1 Msps	2	5	3	16	34			Х		
	CY8C4146AZI-S423	48	64	8	2	0	1	1	1 Msps	2	5	3	16	36				Х	
4146	CY8C4146AXI-S423	48	64	8	2	0	1	1	1 Msps	2	5	3	16	36				\vdash	Х
-	CY8C4146FNI-S433	48	64	8	2	1	1	1	1 Msps	2	5	3	16	31	Х			┝──	<u> </u>
	CY8C4146LQI-S432	48	64	8	2	1	1	1	1 Msps	2	5	3	16	27		Х		\vdash	<u> </u>
	CY8C4146LQI-S433	48	64	8	2	1	1	1	1 Msps	2	5	3	16	34			Х	\vdash	<u> </u>
	CY8C4146AZI-S433	48	64	8	2	1	1	1	1 Msps	2	5	3	16	36			L	X	<u> </u>
	CY8C4146AXI-S433	48	64	8	2	1	1	1	1 Msps	2	5	3	16	36			1		Х



Field	Description	Values	Meaning
CY8C	Cypress Prefix		
4	Architecture	4	PSoC 4
А	Family	1	4100 Family
В	CPU Speed	2	24 MHz
		4	48 MHz
С	Flash Capacity	4	16 KB
		5	32 KB
		6	64 KB
		7	128 KB
DE	Package Code	AX	TQFP (0.8mm pitch)
		AZ	TQFP (0.5mm pitch)
		LQ	QFN
		PV	SSOP
		FN	CSP
F	Temperature Range	I	Industrial
S	Silicon Family	S	PSoC 4A-S1, PSoC 4A-S2
		М	PSoC 4A-M
		L	PSoC 4A-L
		BL	PSoC 4A-BLE
XYZ	Attributes Code	000-999	Code of feature set in the specific family

The nomenclature used in the preceding table is based on the following part numbering convention:

The following is an example of a part number:

Example





Package Diagrams











001-80659 *A



Figure 8. 40-pin QFN Package Outline

NOTES:

1. XXX HATCH AREA IS SOLDERABLE EXPOSED PAD

2. REFERENCE JEDEC # MO-248

3. PACKAGE WEIGHT: 68 ±2 mg

4. ALL DIMENSIONS ARE IN MILLIMETERS



Figure 9. 32-pin QFN Package Outline



Table 42. Acronyms Used in this Document (continued)

Acronym	Description
PC	program counter
PCB	printed circuit board
PGA	programmable gain amplifier
PHUB	peripheral hub
PHY	physical layer
PICU	port interrupt control unit
PLA	programmable logic array
PLD	programmable logic device, see also PAL
PLL	phase-locked loop
PMDD	package material declaration data sheet
POR	power-on reset
PRES	precise power-on reset
PRS	pseudo random sequence
PS	port read data register
PSoC [®]	Programmable System-on-Chip™
PSRR	power supply rejection ratio
PWM	pulse-width modulator
RAM	random-access memory
RISC	reduced-instruction-set computing
RMS	root-mean-square
RTC	real-time clock
RTL	register transfer language
RTR	remote transmission request
RX	receive
SAR	successive approximation register
SC/CT	switched capacitor/continuous time
SCL	I ² C serial clock
SDA	I ² C serial data
S/H	sample and hold
SINAD	signal to noise and distortion ratio
SIO	special input/output, GPIO with advanced features. See GPIO.
SOC	start of conversion
SOF	start of frame
SPI	Serial Peripheral Interface, a communications protocol
SR	slew rate
SRAM	static random access memory
SRES	software reset
SWD	serial wire debug, a test protocol

Table 42.	Acronyms	Used in this Document	(continued)
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Acronym	Description
SWV	single-wire viewer
TD	transaction descriptor, see also DMA
THD	total harmonic distortion
TIA	transimpedance amplifier
TRM	technical reference manual
TTL	transistor-transistor logic
ТΧ	transmit
UART	Universal Asynchronous Transmitter Receiver, a communications protocol
UDB	universal digital block
USB	Universal Serial Bus
USBIO	USB input/output, PSoC pins used to connect to a USB port
VDAC	voltage DAC, see also DAC, IDAC
WDT	watchdog timer
WOL	write once latch, see also NVL
WRES	watchdog timer reset
XRES	external reset I/O pin
XTAL	crystal